Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S2	3434741	@ad> "20030316" @riad> "20030316" @pt1d> "20030316"	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/11 18:28
\$32	1	*10801697*.rlan. or (*10*.src. and *801697*.ap.)	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2006/07/12 20:43
S33	3434741	@ad>"20030316" @rlad>"20030316" @pt1d>"20030316"	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/12 18:13
S34	5829	257/686,777,e25.006,e25.013,e25.018,e25.021,e25.027,e23.085,e21.614.cc/s.	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/12 18:13
S35	859	438/122,FOR.413.cc/s. not S33	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/12 18:13
S36	17146	257/276,625,675,706,707,712-722,796,E33.075,E31.131,E23.051,E23.08-e23.113.cds. not S33	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/12 18:13
S37	17506	(\$36 \$35) not \$33	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/12 18:13
S38	978	438/109,FOR.368,FOR.426.ccls.	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/12 18:13
S39	4739	(S34 S38) not S33	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/12 18:13
S40	530	S39 and S37	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/12 18:13
S41	9336	board with (heatsink heat adj sink spreader) not S33	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/12 18:13
S42	115	S39 and S41	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/12 18:13
\$43	209	S40 and board not S42	US-PGPUB; US-PAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/12 18:13
S44	109	(first second) adj (circuit wiring) adj board with stack\$ not \$33	US-PGPUB; US-PAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/12 18:14
S45	64	(first second) adj (interposer carrier) and S39 not (S33 S44 S42 S43)	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/12 18:13

S46	3850	(first second) adj (circuit wiring) adj board not S33	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/12 18:13
S47	41	S39 and S46	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/12 18:13
S48	1	1994-019998.NRAN.	DERWENT	OR	ON	2006/07/12 18:13
S49	413	["3370203"   "3577037"   "3689684"   "4109096"   "4143456"   "4151543"   "4264917"   "4271426"   "4300153"   "4323914"   "4358552"   "4363076"   "4398235"   "4507675"   "4620757"   "462671"   "4654472"   "4696525"   "4763188"   "4801998"   "4862245"   "4931852"   "4961077"   "4982655"   "4984059"   "5051275"   "510465"   "5104480"   "5108955"   "5111278"   "5138438"   "5144747"   "5158465"   "5173764"   "5184208"   "51949300"   "5218759"   "5220488"   "522048"   "5222014"   "5239448"   "5241456"   "552853"   "5280192"   "5286679"   "5304842"   "5311060"   "5344745"   "5399104"   "5422514"   "5434105"   "5434745"   "5436203"   "5440169"   "5441684"   "5450283"   "5569956"   "5488254"   "5489538"   "548960"   "5502333"   "5515241"   "5523628"   "5552635"   "5569956"   "5579207"   "5585668"   "5585675"   "5587341"   "5598304"   "5783870"   "5831832"   "5866953"   "5679507"   "55895668"   "5504977"   "5907477"   "5910685"   "5969426"   "5976912"   "6005778"   "6013948"   "6028056"   "6028028"   "6087020"   "6030099   "6188127"   "6236568"   "6284569"   "6297548"   "6313522"   "6326240"   "6326544"   "6226696"   "6388333"   "6395582"   "6396143"   "6424030"   "6501165").PN. OR ("2001/0020741"   "2002/0121690"   "55673411"   "5708298"   "5518888"   "67805571   "6782480"   "6521993"   "6586826"   "6527997"   "6650007"   "6693346"   "6730543"   "6781241").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/07/12 18:13
S50	305	S49 not (S33 S44 S42 S43 S45)	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/12 18:13
S51	5364	(upper top) adj2 board with (bottom lower) adj2 board not S33	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/12 18:13
S52	1310	(interposer carrier) and S39 not (S33 S44 S42 S43)	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/12 18:13
S53	4	*05326817*	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/12 18:13
S54	25	watabiki-teruyuki.in.	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/12 18:13
S55	125	("3564114"   "4322778").PN. OR ("4763188").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/07/12 18:26
S56	112	S55 not S33	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/12 18:26
S58	191123	(*438"\$.cds. *257"/\$.ccls.) not S33	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2006/07/19 21:48
S59	59	(automatic adj transmission transmission adj fluid (transmission with coolant)) and \$58 not \$33	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2006/07/12 19:48
S61	25	mechatronic and S58 not S33	US-PGPUB; US-PAT; USOCR; DERWENT	OR	ON	2006/07/12 19:53
S62	2	mechatronic with cool\$5 not S33	US-PGPUB; US-PAT; USOCR; DERWENT	OR	ON	2006/07/12 19:55
S63	0	mechatronic and S37 not S33	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2006/07/12 20:05

S66	138	257/e25.03.cds. not S33	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2006/07/12 20:20
S67	719	439/74.ccts. not \$33	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2006/07/12 20:07
S68	1715	(solder with skie) and (wire with skie) not (solder with wire with skie) not \$33	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2006/07/12 20:24
\$69	2402640	semiconductor integrated adj circuit ic "438"/\$.cds. "257"/\$.cds. 228/280.22.cds. not \$33	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2006/07/12 20:23
S70	1146	S68 and S69	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2006/07/12 20:24
S71	169	(solder with side with board) and (wire with side with board) not (solder with wire with side) not \$33	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2006/07/12 20:28
S72	21	two adj color adj printing adj process	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2006/07/12 20:58
S73	731	257/714.cds. not S33	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2006/07/12 21:39
S74	19	thermoset\$ and S73	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2006/07/12 21:21
S75	76	encaps\$ and S73 not (S33 S74)	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2006/07/12 21:33
S76	19	("5640995"   "5964239"   "6136212"   "6443179").PN. OR ("6548895").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/07/12 21:25
S77	10	S76 not S33	US-PGPUB; USPAT; USOCR	OR	ON	2006/07/12 21:26
S79	4	cotofana.in.	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/12 21:27
\$83	2	encapsuf\$ with groove with fluid with cool\$5 not S33	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/12 21:36
S84	104	S73 and mold\$5 not (S33 S74 S75)	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2006/07/12 21:48
S85	1491	(leadframe lead adj frame) with (copper cu) with (plate\$2 plating clad\$) not S33	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2006/07/13 20:04
S86	324	flex\$5 with polyimide with board with (ceramic glass) not \$33	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/12 21:53
S87	31	S85 and S86	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/13 19:56
S88	3	("3,564,114").PN.	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/07/13 19:57
S89	3440723	@ach "20030316" @rlach "20030316" @pt1ch "20030316"	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/13 19:58
1/20/	2006 12	:44:11 PM	1.2100			Page 3

7/20/2006 12:44:11 PM

590	1491	(leadframe lead adj frame) with (copper cu) with (plate\$2 plating clad\$) not \$89	US-PGPUB; USPAT; USOCR;	OR	ON	2006/07/13 19:58
S91	324	flex\$5 with polyimide with board with (ceramic glass) not S89	US-PGPUB; US-PGPUB; US-PAT; FPRS; EPO; JPO; DERWENT;	OR	ON	2006/07/13 19:58
S92	31	S90 and S91	IBM_TDB  US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/13 20:03
S93	15	(leadframe lead adj frame) with (copper cu) adj (plate\$2 plating clad\$) and (epoxy with (filler)) not S89	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2006/07/13 21:23
S94	362	(leadframe lead adj frame) with (copper cu) adj (plate\$2 plating clad\$) not S89	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2006/07/13 21:22
S96	21	S91 and thermoset\$ and (epoxy with (filler)) not S89	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/13 22:11
S97	7	die adj attach with epoxy with solder with board not S89	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/13 22:13
S98	2	(*20010003373*).PN.	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/07/14 20:44
S99	5	(US-20030137032-\$ or US-20010022404-\$ or US-20010003373-\$).did. or (US-4763188-\$ or US-6548895-\$).did.	US-PGPUB; USPAT	OR	ON	2006/07/14 20:46
S10 0	3	S99 and thermo\$7	US-PĞPÜB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/14 20:46
\$10 1	40	(US-20030137032-\$ or US-20030098504-\$ or US-20010005048-\$ or US-20010022404-\$ or US-20030201525-\$ or US-20020121690-\$ or US-20010020741-\$ or US-20030164540-\$ or US-20030197260-\$ or US-2003003373-\$),did. or (US-35641-\$ or US-5221859-\$ or US-5285104-\$ or US-6627997-\$ or US-6586226-\$ or US-6730543-\$ or US-6781241-\$ or US-6633346-\$ or US-6297548-\$ or US-6262488-\$ or US-5910685-\$ or US-5708298-\$ or US-5138438-\$ or US-4982265-\$ or US-650007-\$ or US-521993-\$ or US-6424030-\$ or US-5587341-\$ or US-6798056-\$ or US-6005778-\$ or US-5880403-\$ or US-4763188-\$ or US-6244331-\$ or US-5319522-\$ or US-5040994-\$ or US-6548895-\$),did. or (US-6429513-\$ or US-6739042-\$ or US-5191404-\$),did.	US-PGPUB; USPAT	OR	ON	2006/07/18 17:25
S10 2	2	ceramic with polyimide and S101	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/19 21:43
S10 4	40	(US-20030137032-\$ or US-20030098504-\$ or US-20010005048-\$ or US-20010022404-\$ or US-20030201525-\$ or US-20020121690-\$ or US-20010020741-\$ or US-20030164540-\$ or US-20030197260-\$ or US-20030038366-\$ or US-20010003373-\$),did. or (US-3564114-\$ or US-5221859-\$ or US-5285104-\$ or US-6627997-\$ or US-6586826-\$ or US-6730543-\$ or US-6781241-\$ or US-6693346-\$ or US-6297548-\$ or US-6262488-\$ or US-5910685-\$ or US-5708298-\$ or US-5138438-\$ or US-4982265-\$ or US-650007-\$ or US-6521993-\$ or US-6424030-\$ or US-5587341-\$ or US-6798056-\$ or US-6005778-\$ or US-580403-\$ or US-4763188-\$ or US-6244331-\$ or US-5319522-\$ or US-5040994-\$ or US-6548895-\$),did. or (US-6429513-\$ or US-6739042-\$ or US-5191404-\$),did.	US-PGPUB; USPAT	OR	ON	2006/07/18 17:25
\$10 5	7	\$104 and thermoset\$	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/18 17:26
S10 6	3	S104 and thermoset\$ and epoxy and filler	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/18 17:26
\$10 7	3452722	@ad>"20030316" @rlad>"20030316" @pt1d>"20030316"	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/19 21:45

S10 8	26	(leadframe lead adj frame) and automatic adj transmission not \$107	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/19 21:46
\$10 9	2	cool\$ and S108	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/19 21:47
S11 0	3452722	@ad>"20030316" @rlad>"20030316" @pt1d>"20030316"	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/19 21:48
\$11 1	191178	("438"\$.cds. "257"/\$.cds.) not S110	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2006/07/19 21:48
S11 2	6	automatic adj transmission and S111	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2006/07/19 21:50
S11 3	1	cool\$5 and S112	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2006/07/19 21:50